

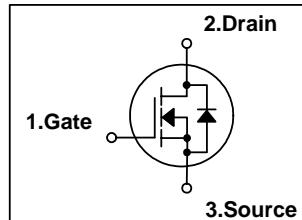


DFP630

## N-Channel MOSFET

### Features

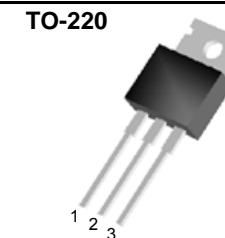
- $R_{DS(on)}$  (Max 0.4 )@ $V_{GS}=10V$
- Gate Charge (Typical 44nC)
- Improved dv/dt Capability
- High ruggedness
- 100% Avalanche Tested



$BV_{DSS} = 200V$   
 $R_{DS(ON)} = 0.4 \text{ ohm}$   
 $I_D = 9A$

### General Description

This N-channel enhancement mode field-effect power transistor using DI semiconductor's advanced planar stripe, DMOS technology intended for off-line switch mode power supply. Also, especially designed to minimize  $r_{ds(on)}$ , low gate charge and high rugged avalanche characteristics. The TO-220 pkg is well suited for DC-DC converter and S-Correction in color-monitor system.



### Absolute Maximum Ratings

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain to Source Voltage	200	V
$I_D$	Continuous Drain Current(@ $T_C = 25^\circ\text{C}$ )	9	A
	Continuous Drain Current(@ $T_C = 100^\circ\text{C}$ )	5.8	A
$I_{DM}$	Drain Current Pulsed (Note 1)	36	A
$V_{GS}$	Gate to Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	180	mJ
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	7.8	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note 3)	5.5	V/ns
$P_D$	Total Power Dissipation(@ $T_C = 25^\circ\text{C}$ )	78	W
	Derating Factor above $25^\circ\text{C}$	0.62	W/ $^\circ\text{C}$
$T_{STG}, T_J$	Operating Junction Temperature & Storage Temperature	- 55 ~ 150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for soldering purpose, 1/8 from Case for 5 seconds.	300	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Value			Units
		Min.	Typ.	Max.	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	-	-	1.61	$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance, Case to Sink	-	0.5	-	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	-	-	62.5	$^\circ\text{C}/\text{W}$

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## Electrical Characteristics ( $T_C = 25^\circ\text{C}$ unless otherwise noted )

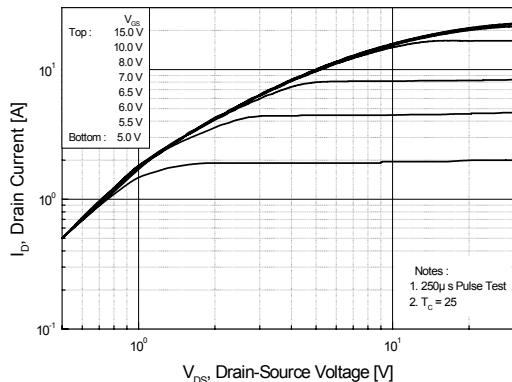
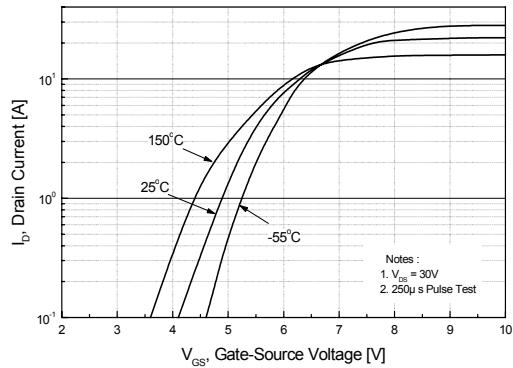
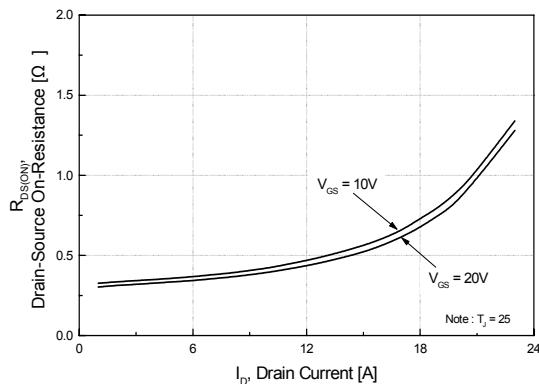
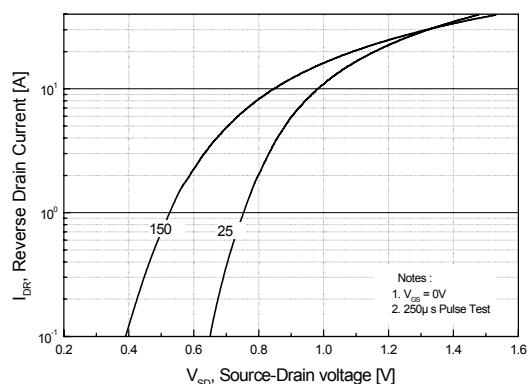
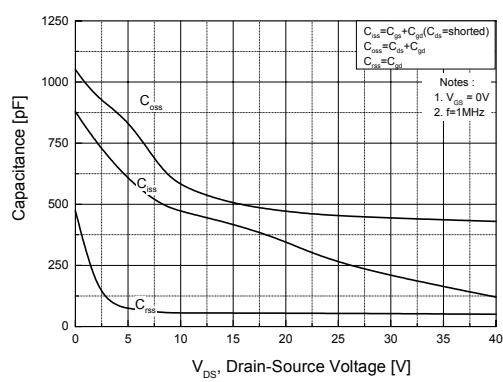
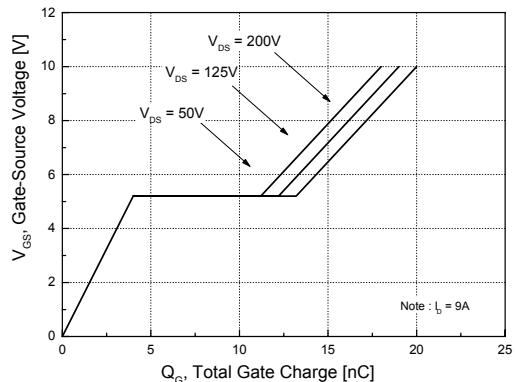
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0\text{V}$ , $I_D = 250\mu\text{A}$	200	-	-	V
$\text{BV}_{\text{DSS}}/T_J$	Breakdown Voltage Temperature coefficient	$I_D = 250\mu\text{A}$ , referenced to $25^\circ\text{C}$	-	0.20	-	V/ $^\circ\text{C}$
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}} = 200\text{V}$ , $V_{\text{GS}} = 0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{\text{DS}} = 160\text{V}$ , $T_C = 125^\circ\text{C}$	-	-	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage, Forward	$V_{\text{GS}} = 25\text{V}$ , $V_{\text{DS}} = 0\text{V}$	-	-	100	nA
	Gate-source Leakage, Reverse	$V_{\text{GS}} = -25\text{V}$ , $V_{\text{DS}} = 0\text{V}$	-	-	-100	nA
<b>On Characteristics</b>						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250\mu\text{A}$	2.0	-	4.0	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-state Resistance	$V_{\text{GS}} = 10\text{V}$ , $I_D = 4.5\text{A}$	-	0.34	0.4	
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}} = 0\text{V}$ , $V_{\text{DS}} = 25\text{V}$ , $f = 1\text{MHz}$	-	450	560	pF
$C_{\text{oss}}$	Output Capacitance		-	95	150	
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	55	90	
<b>Dynamic Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}} = 100\text{V}$ , $I_D = 9\text{A}$ , $R_G = 25\Omega$ see fig. 13. (Note 4, 5)	-	15	30	ns
$t_r$	Rise Time		-	70	140	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	50	90	
$t_f$	Fall Time		-	60	120	
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 160\text{V}$ , $V_{\text{GS}} = 10\text{V}$ , $I_D = 9\text{A}$ see fig. 12. (Note 4, 5)	-	20	30	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	4	-	
$Q_{\text{gd}}$	Gate-Drain Charge(Miller Charge)		-	8	-	

## Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit.
$I_S$	Continuous Source Current	Integral Reverse p-n Junction Diode in the MOSFET	-	-	9	A
$I_{\text{SM}}$	Pulsed Source Current		-	-	36	
$V_{\text{SD}}$	Diode Forward Voltage	$I_S = 9\text{A}$ , $V_{\text{GS}} = 0\text{V}$	-	-	1.5	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_S = 9\text{A}$ , $V_{\text{GS}} = 0\text{V}$ , $dI_F/dt = 100\text{A}/\mu\text{s}$	-	170	-	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		-	0.9	-	$\mu\text{C}$

### NOTES

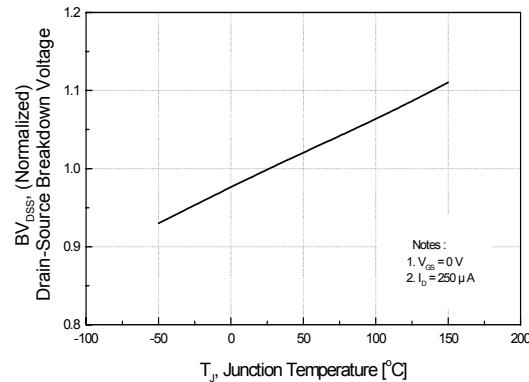
1. Repetitive rating : pulse width limited by junction temperature
2. L = 3.3mH,  $I_{AS} = 9\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 50\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} = 9\text{A}$ ,  $dI/dt = 300\text{A}/\mu\text{s}$ ,  $V_{DD} = \text{BV}_{\text{DSS}}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse Width = 300us, Duty Cycle = 2%
5. Essentially independent of operating temperature.

**DFP630****Fig 1. On-State Characteristics****Fig 2. Transfer Characteristics****Fig 3. On Resistance Variation vs. Drain Current and Gate Voltage****Fig 4. On State Current vs. Allowable Case Temperature****Fig 5. Capacitance Characteristics (Non-Repetitive)****Fig 6. Gate Charge Characteristics**

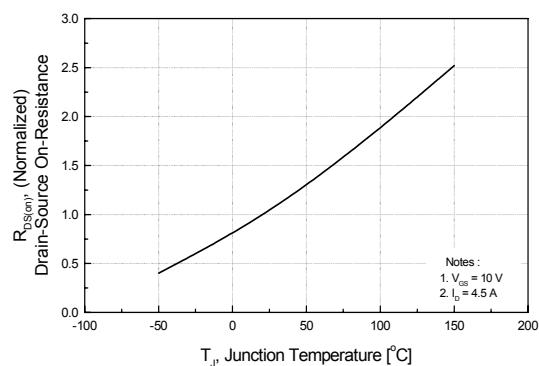
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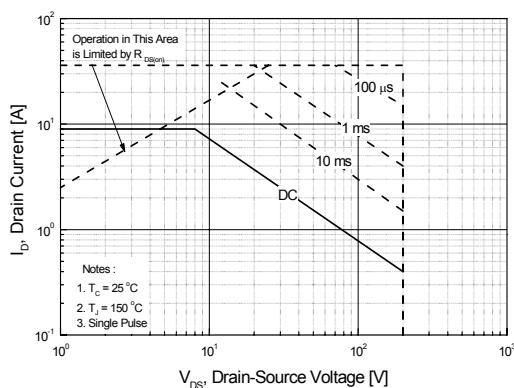
**Fig 7. Breakdown Voltage Variation vs. Junction Temperature**



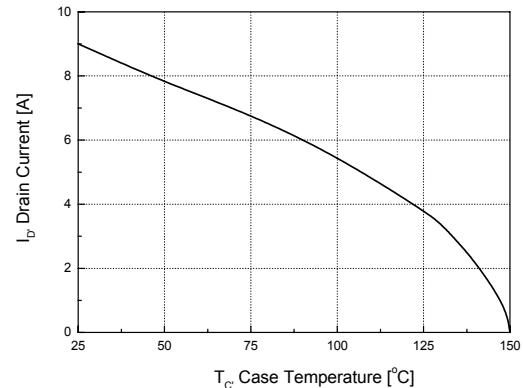
**Fig 8. On-Resistance Variation vs. Junction Temperature**



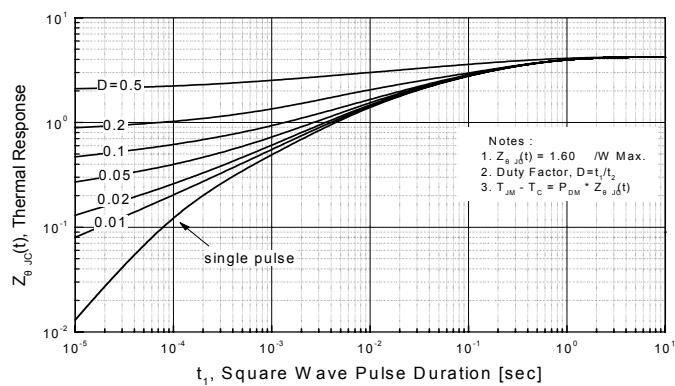
**Fig 9. Maximum Safe Operating Area**

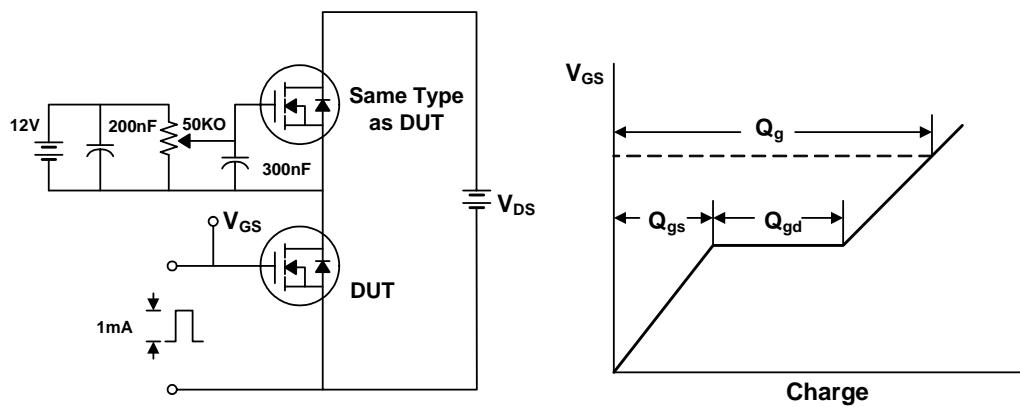
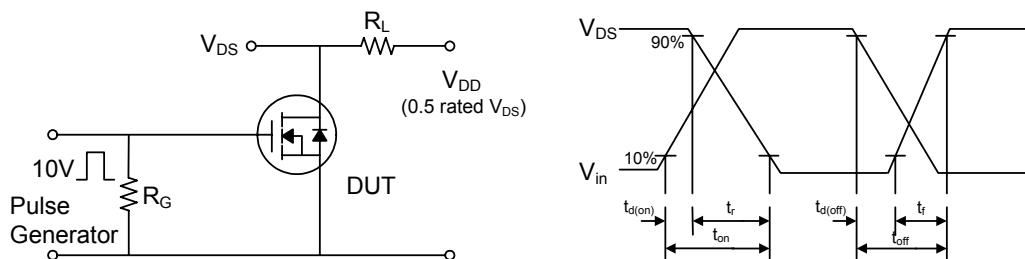
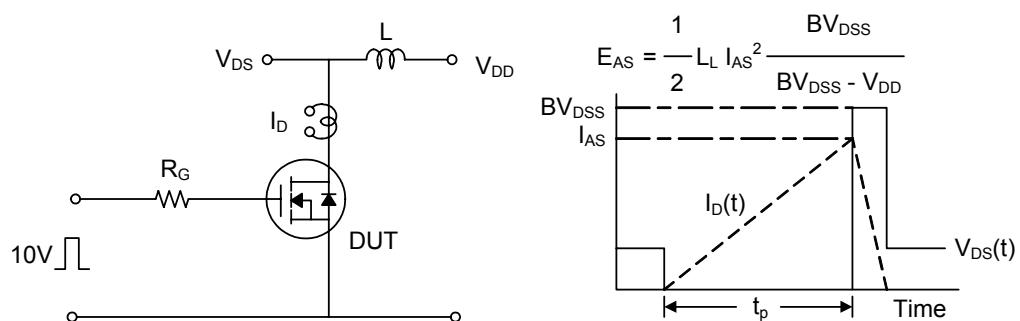


**Fig 10. Maximum Drain Current vs. Case Temperature**



**Fig 11. Transient Thermal Response Curve**

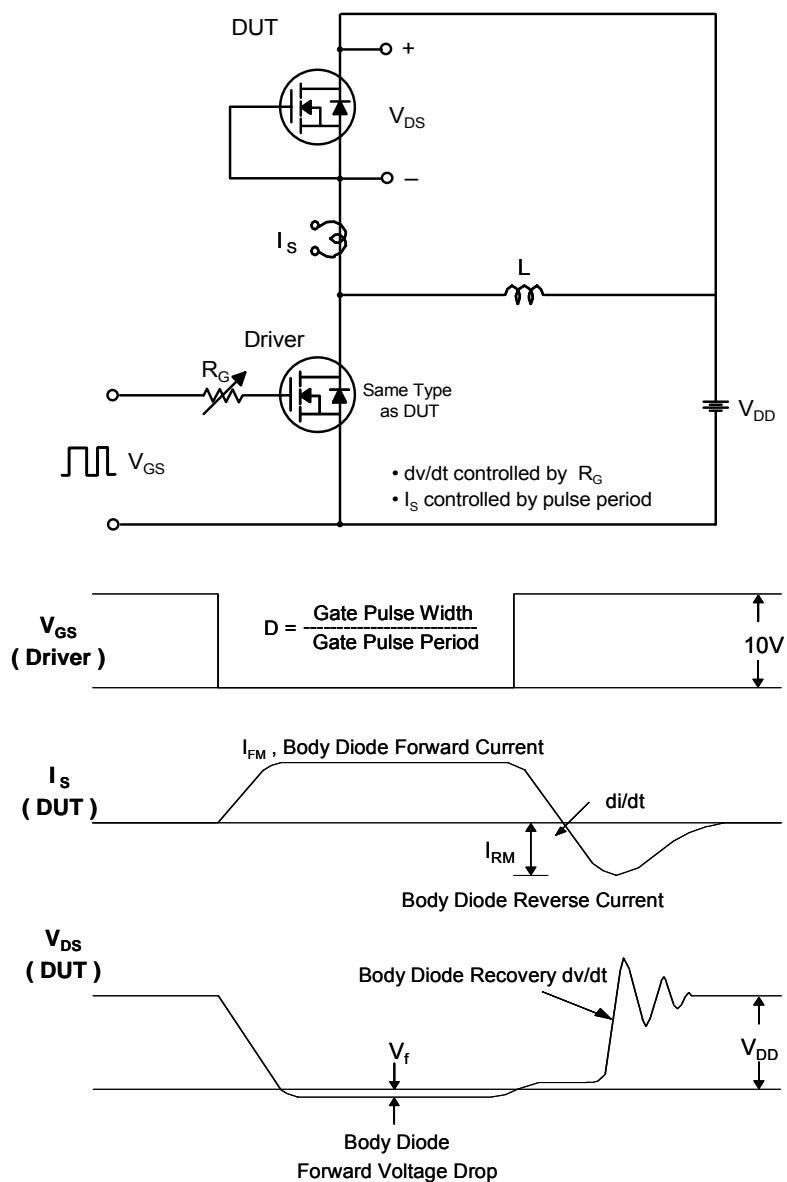


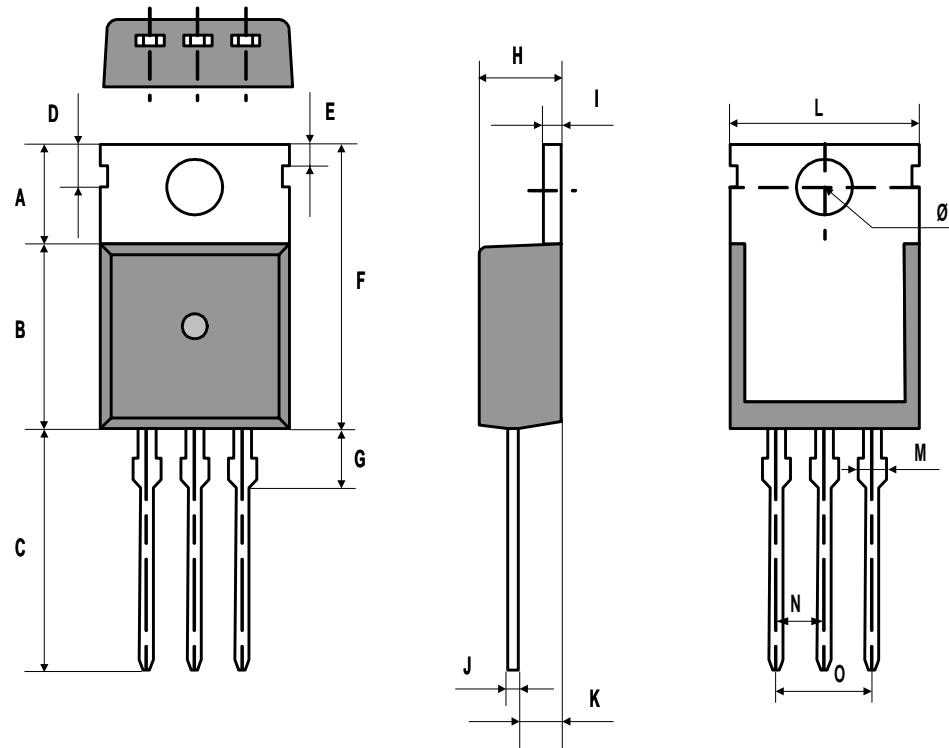
**DFP630****Fig. 12. Gate Charge Test Circuit & Waveforms****Fig 13. Switching Time Test Circuit & Waveforms****Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**

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**Fig. 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms**



**DFP630****TO-220 Package Dimension**

DIMENSION		A	B	C	D	E	F	G	H
mm	Min.	6.12	9.00	12.88	2.70	1.20	15.12	2.70	4.30
	Typ.	6.32	9.20	13.08	2.80	1.30	15.52	3.00	4.50
	Max	6.52	9.40	13.28	2.90	1.40	15.92	3.30	4.70

DIMENSION		I	J	K	L	M	N	O	Ø
mm	Min.	1.25	0.45	2.30		1.42	2.44	4.88	
	Typ.	1.30	0.50	2.40	9.90	1.52	2.54	5.08	3.60
	Max	1.40	0.60	2.50		1.62	2.64	5.28	